

# Flasher, 30-m $\Omega$ Shunt, Pilot Lamp to GND or V<sub>Batt</sub>

### Description

The integrated circuit U2043B is used in relay controlled automotive flashers where a high EMC level is required. A lamp outage is indicated by frequency doubling during

### Features

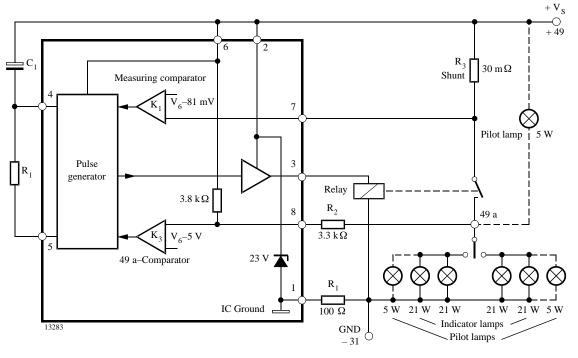
- Temperature and voltage compensated frequency
- Warning indication of lamp failure by means of frequency doubling
- Minimum lamp load for flasher operation  $\geq 10 \text{ W}$

hazard mode as well as direction mode. Pilot lamp can be connected either to  $V_{Batt}\, \text{or GND}.$ 

- Relay output with high current carrying capacity and low saturation voltage
- Low susceptibility to EMI

### **Ordering Information**

Extended Type Number	Package	Remarks
U2043B	DIP8	
U2043B-FP	SO8	



# **Block Diagram**

Figure 1.

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### **Pin Description**

Pin	Symbol	Function
1	GND	IC ground
2	Vs	Supply voltage V <sub>S</sub>
3	REL	Relay driver
4	OSC	C <sub>1</sub> oscillator
5	OSC	R <sub>1</sub> oscillator
6	VS	Supply voltage V <sub>S</sub>
7	LD	Lamp failure detection
8	SI	Start input (49a)

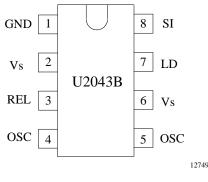


Figure 2. Pinning

### **Functional Description**

#### Pin 1, GND

The integrated circuit is protected against damage via resistor  $R_4$  to ground (-31) in the case of battery reversal. An integrated protection circuit together with external resistances  $R_2$  and  $R_4$  limits the current pulses in the IC.

#### Pin 2, Supply voltage, V<sub>S</sub> - Power

The arrangement of the supply connections to Pin 2 must be such as ensure that, on the connection printed circuit board (PCB), the resistance of  $V_S$  to Pin 6 is lower than that to Pin 2.

#### Pin 3, Relay control output (driver)

The relay control output is a high-side driver with a low saturation voltage and capable to drive a typical automotive relay with a minimum coil resistance of  $60 \Omega$ .

#### Pin 4 and 5 Oscillator

Flashing frequency,  $f_1$ , is determined by the  $R_1C_1$  components as follows (see figure 1):

$$f_1 \approx \frac{1}{R_1 \times C_1 \times 1.5}$$
 Hz

where

$$\begin{array}{l} C_1 \leq \! 47 \; \mu F \\ R_1 = \; 6.8 \; k\Omega \; \text{to} \; 510 \; k\Omega \end{array}$$

In the case of a lamp outage (see Pin 7) the oscillator frequency is switched to the lamp outage frequency  $f_2$  with  $f_2\approx 2.2\,\times\,f_1.$ 

Duty cycle in normal flashing mode: 50% Duty cycle in lamp outage mode: 40% (bright phase)

#### Pin 6, Supply voltage, Sense

For accurate monitoring via the shunt resistor, a mini-

mized layer resistance from point  $V_S\,/$  shunt to Pin 6 is recommended.

#### Pin 7, Lamp outage detection

The lamp current is monitored via an external shunt resistor  $R_3$  and an internal comparator K1 with its reference voltage of typ. 81 mV ( $V_S = 12$  V). The outage of one lamp out of two lamps is detected according to the following calculation:

Nominal current of 1 lamp: 21 W /  $(V_S = 12 V)$ :

 $I_{lamp} = 1.75 \text{ A}$ 

Nominal current of 2 lamps:  $2 \times 21 \text{ W} / (\text{V}_{\text{S}} = 12 \text{ V})$ :

 $I_{lamp} = 3.5 \text{ A}.$ 

The detection threshold is recommended to be set in the middle of the current range:  $I_{outage} \approx 2.7 \text{ A}$ 

Thus the shunt resistor is calculated as:

 $R_3 = V_T (K1) / I_{outage}$ 

 $R_3 = 81 \text{ mV}/2.7 \text{ A} = 30 \text{ m}\Omega.$ 

Comparator K1's reference voltage is matched to the characteristics of filament lamps (see "control signal threshold" in the data part).

The combination of shunt resistor and resistance of wire harness prevents Pin 7 from a too high voltage in the case of shortet lamps.

#### Pin 8, Start input

Start condition for flashing: the voltage at Pin 8 has to be below less than  $V_S - 5 V$  (flasher switch closed).

Humidity and dirt may decrease the resistance between 49 a and GND. If this leakage resistance is > 5 k $\Omega$  the IC is still kept in its off-condition. In this case the voltage at Pin 8 is greater than V<sub>S</sub> – 5 V.

During the bright phase the voltage at Pin 8 is above the K2 threshold, during the dark phase it is below the K3 threshold. For proper start conditions a minimum lamp wattage of 10 W is required.



# **Absolute Maximum Ratings**

Reference point Pin 1

Parameters		Symbol	Value	Unit
Supply voltage	Pins 2, 6	Vs	16.5	V
Surge forward current				
$t_{p} = 0.1 \text{ ms}$	Pins 2, 6	I <sub>FSM</sub>	1.5	A
$t_p = 2 \text{ ms}$	Pins 2, 6	I <sub>FSM</sub>	1.0	A
$t_p = 2 \text{ ms}$	Pin 8	I <sub>FSM</sub>	50	mA
Output current	Pin 3	IO	0.3	A
Power dissipation				
$T_{amb} = 95^{\circ}C$	DIP8	P <sub>tot</sub>	420	mW
	SO8	P <sub>tot</sub>	340	mW
$T_{amb} = 60^{\circ}C$	DIP8	P <sub>tot</sub>	690	mW
	SO8	P <sub>tot</sub>	560	mW
Junction temperature		Tj	150	°C
Ambient temperature ran	ge	T <sub>amb</sub>	-40 to +95	°C
Storage temperature rang	je	T <sub>stg</sub>	-55 to +150	°C

### **Thermal Resistance**

Parameters		Symbol	Value	Unit
Junction ambient	DIP8	R <sub>thJA</sub>	110	K/W
	SO8	R <sub>thJA</sub>	160	K/W

### **Electrical Characteristics**

Typical values under normal operation in application circuit figure 1,  $V_S$  (+49, Pins 2 and 6) = 12 V. Reference point ground (-31),  $T_{amb} = 25^{\circ}C$ , unless otherwise specified

Parameters	Test Conditio	ons / Pins	Symbol	Min.	Тур.	Max.	Unit
Supply voltage range		Pins 2, 6	V <sub>S</sub> (+49)		9 to 15		V
Supply current	Dark phase or stand-by	Pins 2, 6	I <sub>S</sub>		4.5	8	mA
Supply current	Bright phase	Pins 2, 6	Is		7.0	11	mA
Relay output	Saturation volta, $I_O = 150 \text{ mA},$ $V_S = 9 \text{ V}$	ge Pin 3	Vo			1.0	v
Relay output reverse current		Pin 3	I <sub>O</sub>			0.1	mA
Relay coil resistance			R <sub>L</sub>	60			Ω
Start delay	First bright phas	e	t <sub>on</sub>			10	ms
Frequency determining resistor			R <sub>1</sub>	6.8		510	kΩ
Frequency determining capacitor			C <sub>1</sub>			47	μF

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# **Electrical Characteristics (continued)**

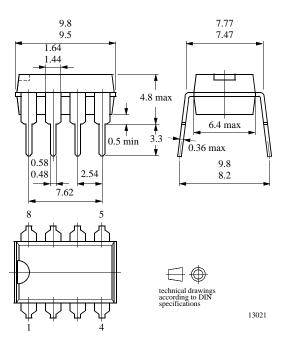
Parameters	Test Conditions / Pins	Symbol	Min.	Тур.	Max.	Unit
Frequency tolerance	Normal flashing, basisc fre- quency $f_1$ not including the tolerance of the external components $R_1$ and $C_1$	$\Delta f_1$	-5		+5	%
Bright period	Basic frequency f <sub>1</sub>	$\Delta f_1$	47		53	%
Bright period	Control frequency f <sub>2</sub>	$\Delta f_2$	37		45	%
Frequency increase	Lamp outage	f <sub>2</sub>	$2.15 \times f_1$		$2.3 \times f_1$	Hz
Control signal threshold	$V_{\rm S} = 15 \text{ V}$ Pin 7	V <sub>R3</sub>	85	91	97	mV
	$V_S = 9 V$	V <sub>R3</sub>	66	71	76	mV
	$V_{S} = 12 V$	V <sub>R3</sub>	76	81	87	mV
Leakage resistance	49a to GND	Rp		2	5	kΩ
Lamp load		PL	10			W



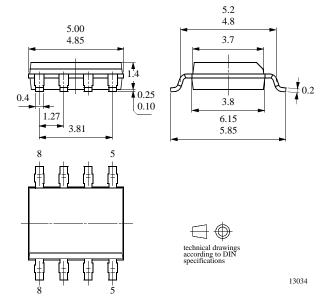
## **Package Information**

### Package DIP8

Dimensions in mm



### Package SO8 Dimensions in mm



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# **Ozone Depleting Substances Policy Statement**

#### It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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